



AO7402

N-Channel Enhancement Mode Field Effect Transistor

General Description

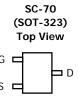
The AO7402 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V, in the small SOT323 footprint. It can be used for a wide variety of applications, including load switching, low current inverters and low current DC-DC converters. Standard Product AO7402 is Pb-free (meets ROHS & Sony 259 specifications). AO7402L is a Green Product ordering option. AO7402 and AO7402L are electrically identical.

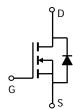
Features

 $V_{DS}(V) = 20V$ $I_{D} = 1.6 \text{ A } (V_{GS} = 4.5V)$ $R_{DS(ON)} < 90 \text{m}\Omega (V_{GS} = 4.5V)$

 $R_{DS(ON)} < 105 m\Omega (V_{GS} = 2.5V)$

 $R_{DS(ON)}$ < 130m Ω (V_{GS} = 1.8V)





Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Maximum	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
		V _{DS}	20		
		V_{GS}	±8		
Continuous Drain	T _A =25°C		1.6		
Current ^A	T _A =70°C	I _D	1.2	A	
Pulsed Drain Current ^B		I _{DM}	10	1	
	T _A =25°C	В	0.35	W	
Power Dissipation A	T _A =70°C	$-P_{D}$	0.22	¬	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics									
Parameter	Symbol	Тур	Typ Max Un						
Maximum Junction-to-Ambient A	t ≤ 10s)s R _{0JA}		360	°C/W				
Maximum Junction-to-Ambient A	Steady-State	$\kappa_{\theta JA}$	340	425	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	280	320	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS					
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V, V _{GS} =0V			1	μА
		T _J =55	°C		5	μιτ
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±8V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	0.4	0.55	0.8	V
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	10			Α
R _{DS(ON)} St	Static Drain-Source On-Resistance	V _{GS} =4.5V, I _D =1.6A		75	90	mΩ
		T _J =125	°C	106	130	11152
	Static Drain-Source On-Nesistance	V _{GS} =2.5V, I _D =1.5A		86	105	mΩ
		V _{GS} =1.8V, I _D =1.4A		103	130	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =1.6A		5.5		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.69	1	V
I _S	Maximum Body-Diode Continuous Curr			0.5	Α	
DYNAMI	CPARAMETERS					
C _{iss}	Input Capacitance			458		pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =10V, f=1MHz		76		pF
C _{rss}	Reverse Transfer Capacitance			54		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		3		Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge			6.05		nC
Q_{gs}	Gate Source Charge	V_{GS} =4.5V, V_{DS} =10V, I_{D} =1.6A		0.7		nC
Q_{gd}	Gate Drain Charge			1.45		nC
t _{D(on)}	Turn-On DelayTime			7.3		ns
t _r	Turn-On Rise Time	V_{GS} =5V, V_{DS} =10V, R_L =6.25 Ω ,		5.6		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =6 Ω		40		ns
t _f	Turn-Off Fall Time			11		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =1.6A, dI/dt=100A/μs		12.2		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =1.6A, dI/dt=100A/μs		3.23		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

Rev 3: Sept 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

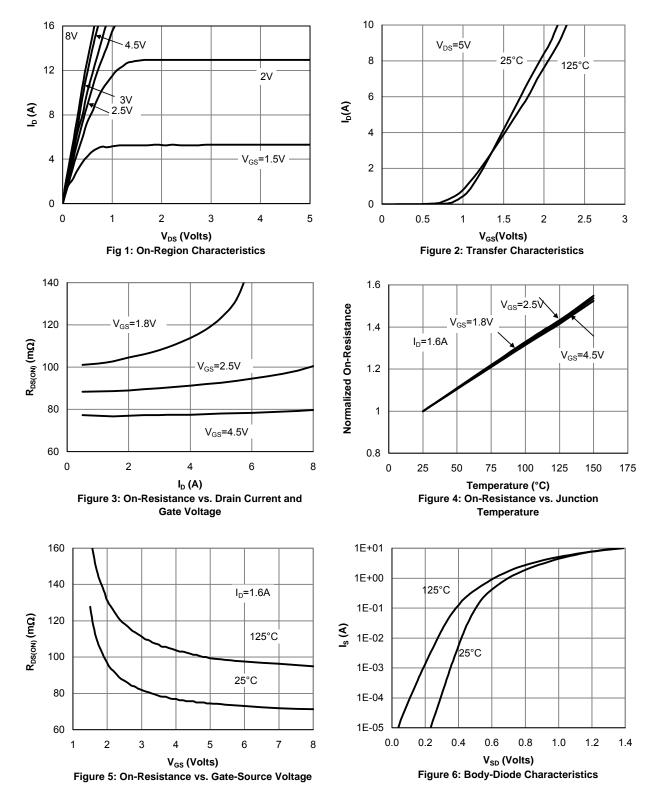
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

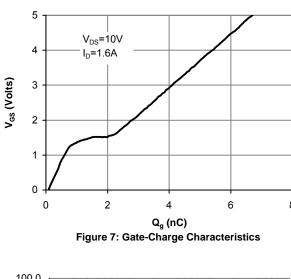
D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

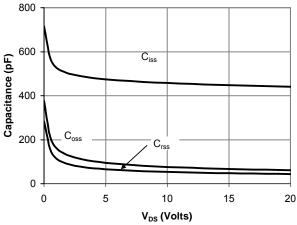
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

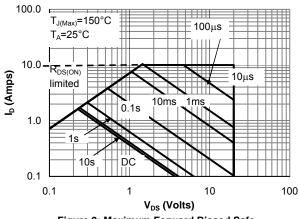


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS











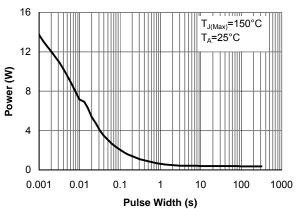


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

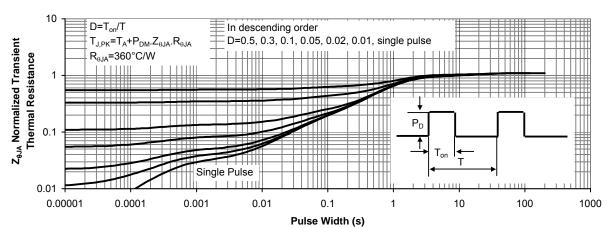


Figure 11: Normalized Maximum Transient Thermal Impedance